LNJ816C88RA

Hight Bright Surface Mounting Chip LED

Microlens Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	55	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

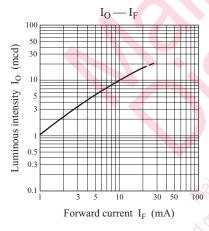
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

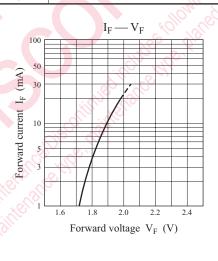
■ Lighting Color

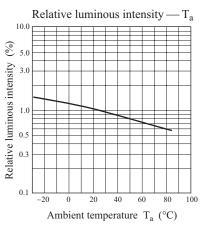
Orange

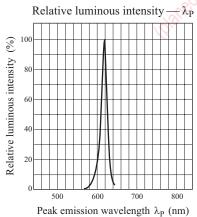
■ Electro-Optical Characteristics $T_a = 25$ °C

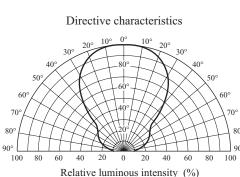
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O	$I_F = 10 \text{ mA}$	5.2	9.8	(5)	mcd
Reverse current	I_{R}	$V_R = 4 V$,,,¢i,	1080	10	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	0,000,00	1.90	2.50	V
Peak emission wavelength	λ_{P}	$I_F = 10 \text{ mA}$	III MIND	620		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	ie O.	17		nm

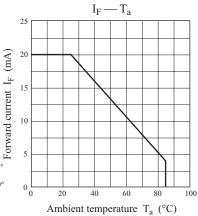








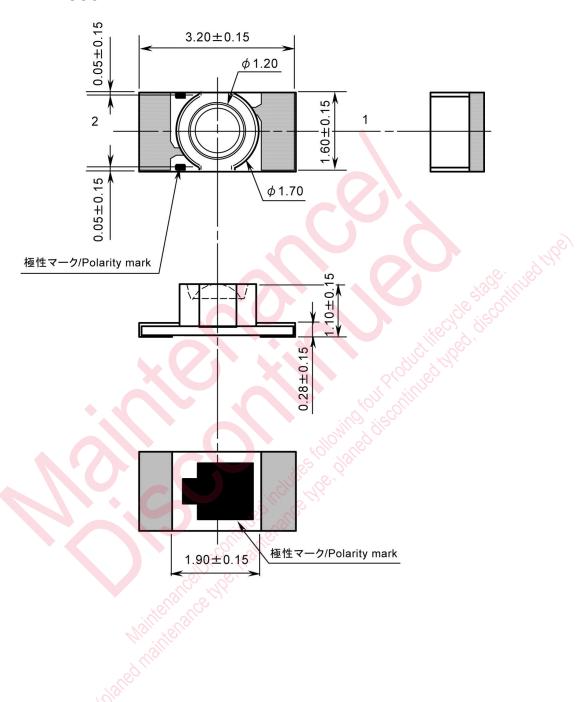




LNJ816C88RA Panasonic

■ Package (Unit: mm)

KLTLTN2K1600



- Pin Name
 - 1: Anode

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2: Cathode

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